

## APPLICATIONS

- ✓ Cellular Phones
- ✓ Notebooks
- ✓ Personal Digital Assistant (PDA)
- ✓ Ground Positioning System (GPS)
- ✓ SMART Card

## IEC COMPATIBILITY (EN61000-4)

- ✓ 61000-4-2 (ESD): Air - 15kV, Contact - 8kV
- ✓ 61000-4-4 (EFT): 40A - 5/50ns

## FEATURES

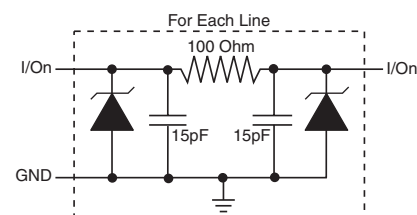
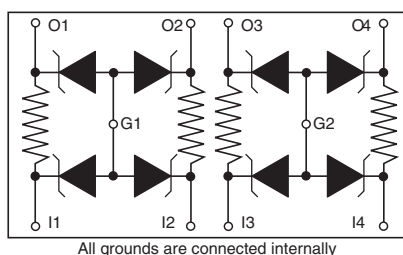
- ✓ ESD Protection > 25 kilovolts
- ✓ Bidirectional EMI Filtering/TVS Low Pass Filters
- ✓ Low Insertion Loss: -3db Roll-Off @ 90MHz
- ✓ Protects Up to Four(4) Data Lines
- ✓ RoHS Compliant

## MECHANICAL CHARACTERISTICS

- ✓ 10 Bump Flip Chip Package
- ✓ Weight 0.73 milligrams (Approximate)
- ✓ Available in Lead-Free Plating
- ✓ Solder Reflow Temperature:  
Lead-Free - Sn/Ag/Cu, 96/3.5/0.5: 260-270°C
- ✓ Consult Factory for Leaded Device Availability
- ✓ Flammability Rating UL 94V-0
- ✓ 8mm Tape and Reel Per EIA Standard 481



## PIN CONFIGURATION



# EMIF4-100LFC

## DEVICE CHARACTERISTICS

### MAXIMUM RATINGS @ 25°C Unless Otherwise Specified

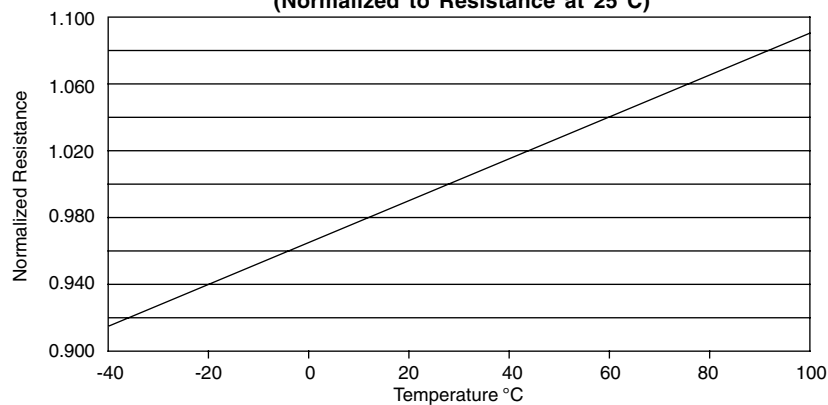
PARAMETER	SYMBOL	VALUE	UNITS
Operating Temperature	$T_A$	-40°C to 85°C	°C
Storage Temperature	$T_{STG}$	-55°C to 150°C	°C
DC Power Per Resistor	P	100	mW
Typical Resistance @ ± 20%	R	100	OHMS

### ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified

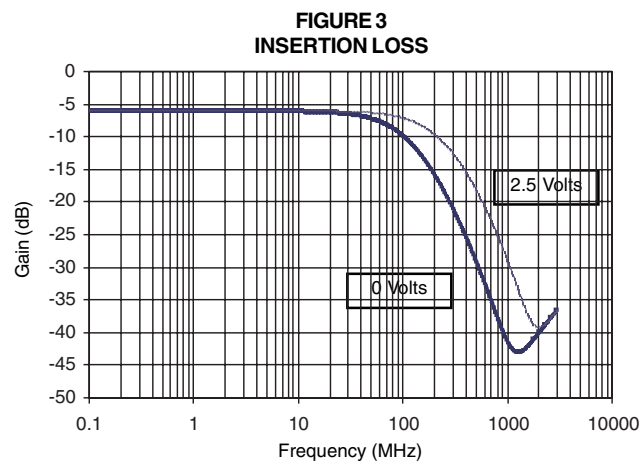
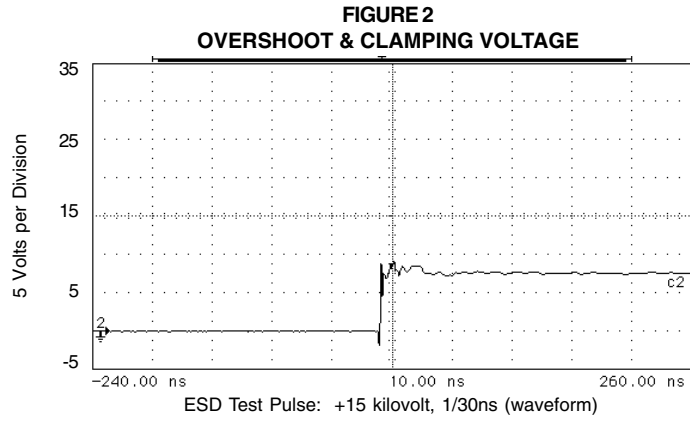
PART NUMBER	RATED STAND-OFF VOLTAGE $V_{WM}$ VOLTS	MINIMUM BREAKDOWN VOLTAGE @ 1mA $V_{(BR)}$ VOLTS	MAXIMUM REVERSE LEAKAGE CURRENT @ 3V $I_b$ $\mu A$	TYPICAL FORWARD VOLTAGE @ 10mA $V_F$ VOLTS	MINIMUM ATTENUATION @ 800-3000 MHz dB	CUT-OFF FREQUENCY (50 OHMS I/O) ZERO BIAS fC MHz	TYPICAL CAPACITANCE PERLINE (See Note 1) @ 2.5V, 1MHz $C_{LINE}$ pF
EMIF4-100LFC	5.0	6.0	0.1	0.8	30	90	30

**Note 1:** ± 20% tolerance.

**FIGURE 1**  
**RESISTANCE VS TEMPERATURE**  
(Normalized to Resistance at 25°C)



## GRAPHS

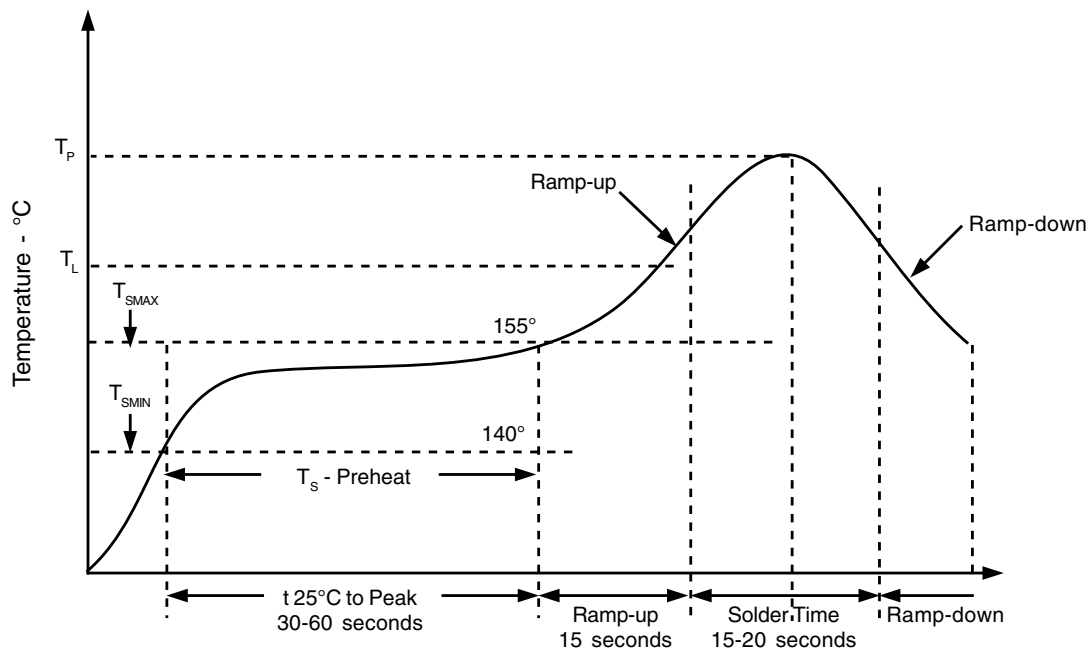
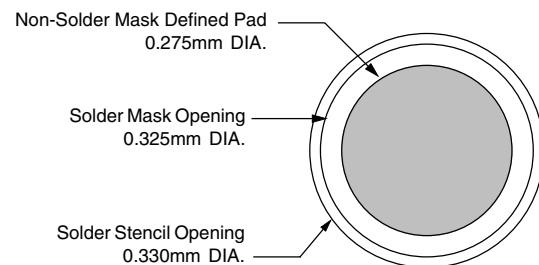


## SOLDER RECOMMENDATIONS

PRINTED CIRCUIT BOARD RECOMMENDATIONS	
PARAMETER	VALUE
Pad Size on PCB	0.275mm
Pad Shape	Round
Pad Definition	Non-Solder Mask Defined Pads
Solder Mask Opening	0.325mm Round
Solder Stencil Thickness	0.150mm
Solder Stencil Aperture Opening (laser cut, 5% tapered walls)	0.330mm Round
Solder Paste Type	No Clean
Pad Protective Finish	OSP(Entek Cu Plus 106A)
Tolerance - Edge To Corner Ball	±50µm
Solder Ball Side Coplanarity	±20µm
Maximum Dwell Time Above Liquidous (183°C)	60 Seconds
Soldering Maximum Temperature	270°C

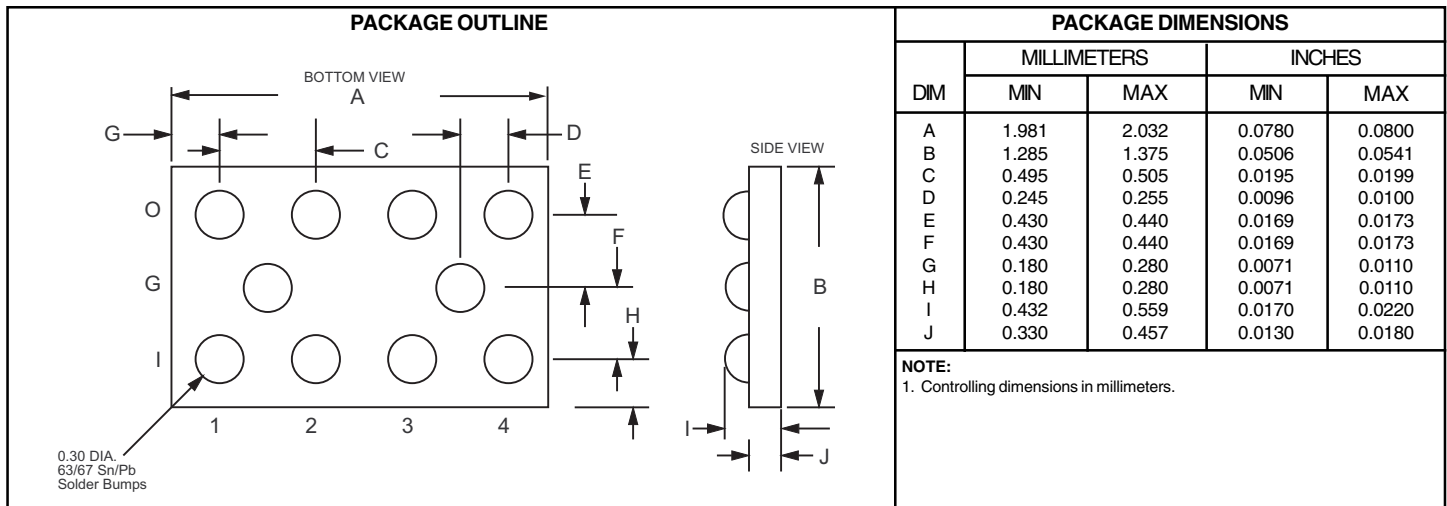
REQUIREMENTS
<p>Temperature:</p> <p><math>T_p</math> for Lead-Free (SnAgCu): 260-270°C</p> <p><math>T_p</math> for Tin-Lead: 240-245°C</p> <p>Preheat time and temperature depends on solder paste and flux activation temperature, component size, weight, surface area &amp; plating.</p>

### RECOMMENDED NON-SOLDER MASK DEFINED PAD ILLUSTRATION



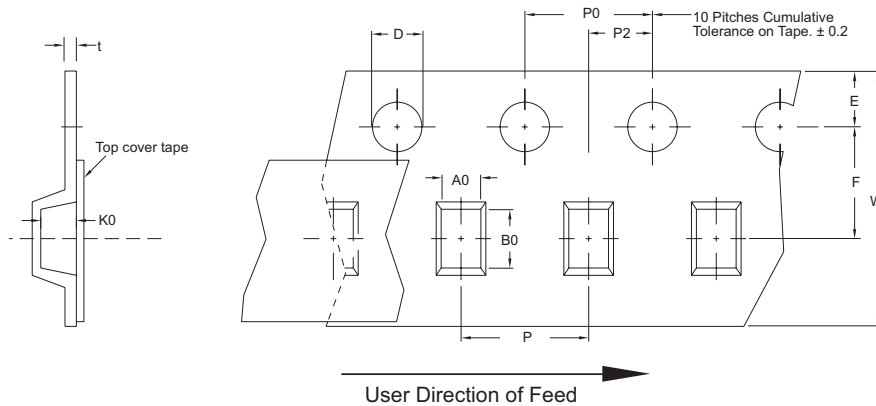
# EMIF4-100LFC

## 10 BUMP FLIP CHIP PACKAGE OUTLINE & DIMENSIONS



Tape & Reel Specifications (Dimensions in millimeters)

Reel Dia.	Tape Width	A0	B0	K0	D	E	F	W	P0	P2	P	t
178mm (7")	8mm	1.78 ± 0.05	2.18 ± 0.05	0.51 ± 0.05	1.50 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	8.00 ± 0.30	4.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.10	0.20 ± 0.025



### TAPE & REEL ORDERING NOMENCLATURE

1. Surface mount product is taped and reeled in accordance with EIA-481.
2. Plastic 8mm Tape: Suffix-T73-1 = 7 Inch Reel - 3,000 pieces per reel, i.e., *EMIF4-100LFC-T73-1*.
3. Suffix - LF - Lead-Free, i.e., *EMIF4-100LFC-LF-T73-1*.

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